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## TM signs R&D pact with Mimos

Malaysia: Telekom Malaysia Bhd (TM)
has announced that it has signed a three-year
collaborative agreement with Mimos Bhd that
will enable both companies to spearhead efforts
on research and development (R&D) projects,
commercialisation and potential technology transfer
of grid computing, semantic, wireless access and
Internet Protocol Version 6 (IPv6).

TM has hailed the signing of the R&D pact with Mimos, stating that this will lead to the development of more innovative technologies that will enhance future offerings by TM to meet future market needs. Mimos also said that the transfer of technologies from Mimos labs to TM is in line with its objectives to grow competitive indigenous industries globally which will further develop Malaysia's ICT industry.